TOSHIBA Diode Silicon Epitaxial Planar Type

HN1D02F

Ultra High Speed Switching Application

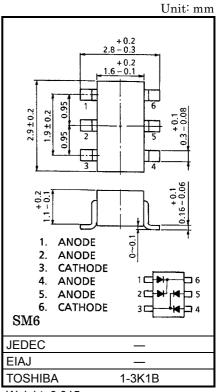
 $\bullet \ \ HN1D02F$ is composed of 2 unit of cathode common.

• Low forward voltage $: V_{F(3)} = 0.90V \text{ (typ.)}$ • Fast reverse recovery time: $t_{rr} = 1.6 \text{ns (typ.)}$ • Small total capacitance $: C_T = 0.9 \text{pF (typ.)}$

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	V_{RM}	85	V	
Reverse voltage	V _R	80	V	
Maximum (peak) forward current	I _{FM}	300 (*)	mA	
Average forward current	Io	100 (*)	mA	
Surge current (10ms)	I _{FSM}	2 (*)	Α	
Power dissipation	Р	300	mW	
Junction temperature	Tj	125	°C	
Storage temperature	T _{stg}	-55~125	°C	

(*) This is the Maximum Ratings of single diode (Q1 or Q2 or Q3 or Q4). In the case of using Unit 1 and Unit 2 independently or simultaneously, the Maximum Ratings per diode is 75% of the single diode one.



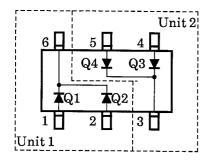
Weight: 0.015g

Electrical Characteristics (Q1, Q2, Q3, Q4 Common, Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F (1)}	_	I _F = 1mA	-	0.60	1	V
	V _{F (2)}	_	I _F = 10mA	_	0.72	_	
	V _{F (3)}	_	I _F = 100mA	_	0.90	1.20	
Reverse current	I _{R (1)}	_	V _R = 30V	-	_	0.1	μА
	I _{R (2)}	_	V _R = 80V	_	_	0.5	
Total capacitance	C _T	_	V _R = 0, f = 1MHz	_	0.9	3.0	pF
Reverse recovery time	t _{rr}	_	I _F =10mA (Fig.1)	_	1.6	4.0	ns

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Pin Assignment (Top View)



Marking

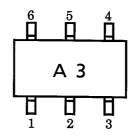
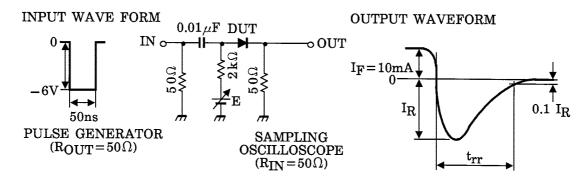
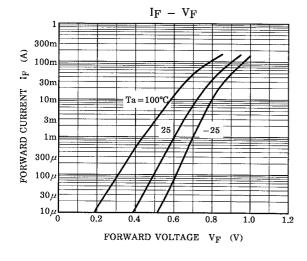
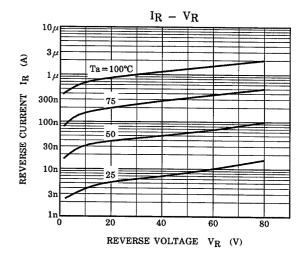


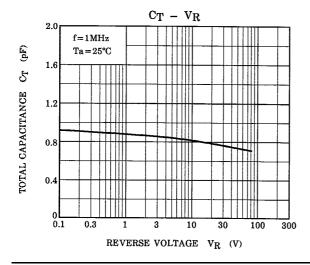
Fig.1 Reverse Recovery Time (trr) Test Circuit



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